

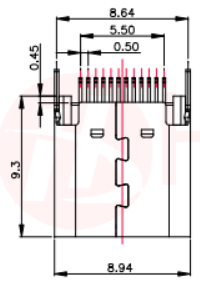
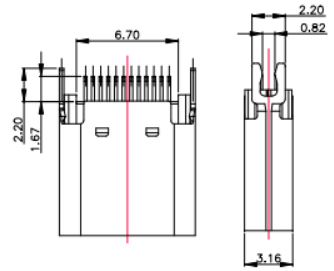
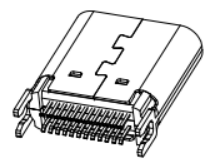
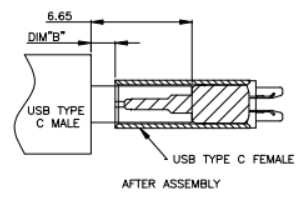
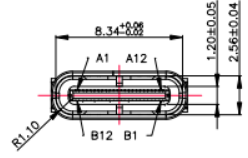
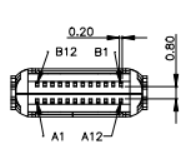
## Type-C母座24PIN夹板母座长体带K脚 夹板0.8高9.3/10.4

产品名称	Type-C母座24PIN夹板母座长体带K脚 夹板0.8高9.3/10.4
生产厂家	东莞市汉博电子科技有限公司
价格	1.50/个
规格参数	汉博:Type-C MC:233 广东省:东莞市
公司地址	塘厦镇莲湖南路68号1号楼330室
联系电话	15377753702

### 产品详情

Type-C母座24PIN夹板母座长体带K脚 夹板0.8高9.3/10.4

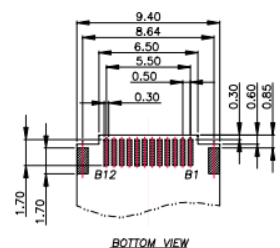
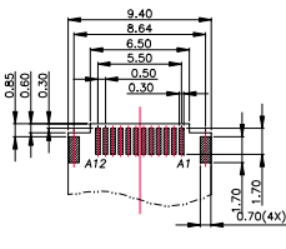
REV.	ECN NO OR DESCRIPTION	REVISED	DATE



USB TYPE-C PIN ASSIGNMENTS

PIN NUMBER	SIGNAL NAME	PIN NUMBER	SIGNAL NAME
A1	GND	B12	GND
A2	SSTxp1	B11	SSRxp1
A3	SSTxm1	B10	SSRxm1
A4	Vbus	B9	Vbus
A5	CC1	B8	SBU2
A6	Dp1	B7	Dn2
A7	Dn1	B6	Dp2
A8	SBU1	B5	CC2
A9	Vbus	B4	Vbus
A10	SSRxm2	B3	SSTxm2
A11	SSRxp2	B2	SSTxp2
A12	GND	B1	GND

NOTE:  
 1.MATERIAL SPECIFICATION:  
 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.  
 2.CONTACTS: COPPER ALLOY(C1814)  
 3.MID PLATE: STAINLESS STEEL(SUS301)  
 4.FRONT SHELL: STAINLESS STEEL(SUS304)  
 2.PLATING SPECIFICATION:  
 2-1.TERMINAL:  
 N° 50µ" MIN. UNDER PLATED OVER ALL.  
 Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.  
 (GOLD PLATING THICKNESS FOLLOW THE P/N)  
 PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N  
 2-2.FRONT SHELL:  
 PLATING SPECIFICATIONS FOLLOW THE P/N  
 2-3.MID PLATE:  
 CLEAR ONLY  
 3.MECHANICAL PERFORMANCE,  
 3-1.INSERTION FORCE: 0.5~2.0kgf.  
 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.  
 3-3.DURABILITY: 10000 CYCLES.  
 4.ELECTRICAL PERFORMANCE,  
 4-1. CURRENT RATING:5.0A  
 VOLTAGE RATING:5.0V  
 4-2. LLCR:  
 VBUS & GND PINS AND OTHER PINS: 40ms/PIN MAX.  
 SHIELD: 50ms/MAX.  
 LLCR MAX. CHANGE OF ALL PINS: 10ms.  
 4-3.INSULATION RESISTANCE: 100MΩ MIN  
 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.  
 5. ENVIRONMENTAL PERFORMANCE:  
 OPERATING TEMPERATURE: -25°C~+85°C.  
 6.IR REFLOW:  
 THE PEAK TEMPERATURE ON THE BOARD SHALL  
 BE MAINTAINED FOR 10 SECONDS AT 260°C.



RECOMMENDED PCB LAYOUT(TOP VIEW)  
 THICKNESS 0.8.0±0.05MM-DEFAULT TOLERANCE:±0.05

BOTTOM VIEW

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X :±0.30	X :±2°
X.X :±0.20	X.X :±1°
X.XX :±0.10	

东莞市汉博电子科技有限公司  
 DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	USB C F SPLINT CONN WITHOUT EMI PCB=0.8
DWN	xiong PART NO. MC-233J08H93
CHKD	lee SCALE:1:1 UNIT: mm
APVD	wang SIZE: A4 SHEET:10F 1 REV: A4

CUSTOMER COPY